

Discription

The HDESD3V3XA1BCSF-7 protects sensitive semiconductor components from damage or upset due to electrostatic discharge (ESD) and other voltage induced transient events. Excellent clamping capability, low leakage, low capacitance, and fast response time provide best in class protection on designs that are exposed to ESD.	
It gives designer the flexibility to protect one bi-directional line in applications where arrays are not practical.	DFN0603-2L
Features	

- ★ Transient protection for high-speed data lines IEC 61000-4-2(ESD) ±30kV (Contact) ±30kV (Air)
 IEC 61000-4-4(EFT) 40A (5/50 ns)
- ★ Peak power dissipation: 80W(8/20us)
- ★ Working voltages : 3.3V
- ★ Ultra-small package (0.6mmx0.3mmx0.3mm)
- ★ Protects one I/0 line
- ★ Low clamping voltage
- ★ Low leakage current

Orderingin formation

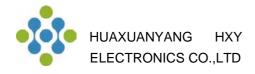
Product ID	Pack	Qty(PCS)
HDESD3V3XA1BCSF-7	DFN0603-2L	10000

Absolute Ratings(Tamb = 25°C)

Symbol	Parameter		Units
P _{PP}	Peak Pulse Power (t _P = 8/20µs)	80	W
TL	Maximum lead temperature for soldering during 10s	260	°C
T _{stg}	Storage Temperature Range	-55 to +150	°C
T _{op}	Operating Temperature Range		°C
Tj	Maximum junction temperature		°C
	IEC61000-4-2 (ESD) air dischar contact dischar		κv

1 0 2

Circuit Diagram

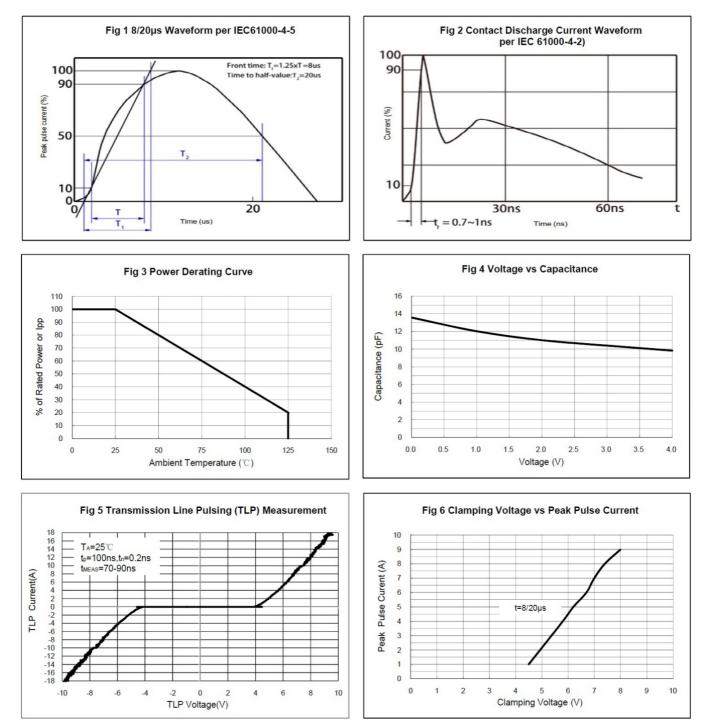


Electrical Characteristics

Symbol	Parameter	Test Condition	Min	Тур	Max	Units
Vrwm	Reverse Working Voltage				3.3	V
Vbr	Reverse Breakdown Voltage	l⊤ = 1mA	3.6			V
IR	Reverse Leakage Current	V _{RWM} = 3.3V			1.0	μA
Vc		$I_{RWM} = 1A, t_{P} = 8/20 \mu s$		4.5	6.0	V
VC	Clamping Voltage	$I_{RWM} = 8A, t_{P} = 8/20 \mu s$			10	V
Vctlp	TLP Clamping Voltage	IPP = 16A IEC61000-4-2 Level 4 equivalent (±8kV Contact, ±15kV Air)		9.0		V
C	Junction Capacitance	$V_R = 0V, f = 1MHz$		0.6	0.7	pF

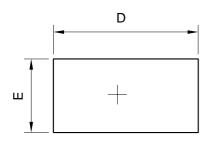


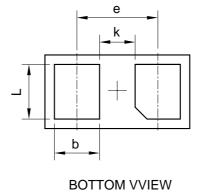
Typical Characteristics





Outline And Dimensions





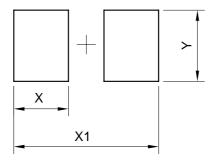
DFN0603-2L			
Dim	Min	Тур.	Max
D	0.58	0.61	0.64
Е	0.28	0.31	0.34
е	-	0.34	-
L	0.20	0.23	0.26
b	0.16	0.19	0.22
А	0.25	0.28	0.31
k	0.12	0.15	0.18
All Dimensions in mm			

TOP VIEW



SSIDE VIEW

Soledering Footprint



DFN0603-2L		
DIM	(mm)	
Х	0.23	
X1	0.61	
Y	0.30	



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